



## 30V/5.8A N-Channel Advanced Power MOSFET

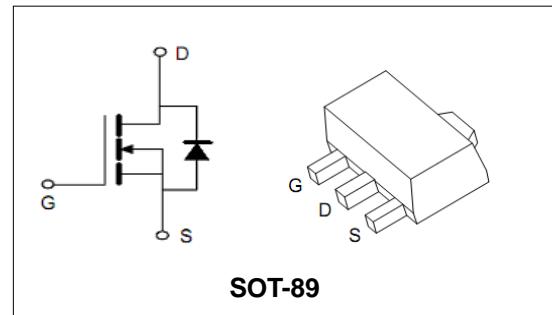
**Features**

- Advanced trench process technology
- High Density Cell Design For Ultra Low On-Resistance

BVDSS	30	V
ID	5.8	A
RDSON@VGS=10V	22	mΩ
RDSON@VGS=4.5V	25	mΩ
RDSON@VGS=2.5V	33	mΩ

**Applications**

- Low Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others

**Order Information**

Product	Package	Marking	Reel Size	Reel	Carton
PTG3400	SOT-89	JH34	7inch	1000PCS	40000PCS

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>				
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	30	V	
V <sub>GS</sub>	Gate-Source Voltage	±12	V	
T <sub>J</sub>	Maximum Junction Temperature	150	°C	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
I <sub>S</sub>	Diode Continuous Forward Current	TA =25°C	1.6	A

**Mounted on Large Heat Sink**

I <sub>DM</sub>	Pulse Drain Current Tested (Silicon Limit) (Note1)	TA =25°C	30	A
I <sub>D</sub>	Continuous Drain current	TA =25°C	5.8	A
P <sub>D</sub>	Maximum Power Dissipation	TA =25°C	1.4	W
R <sub>θJA</sub>	Thermal Resistance Junction-to-Ambient (Note2)		89.2	°C/W

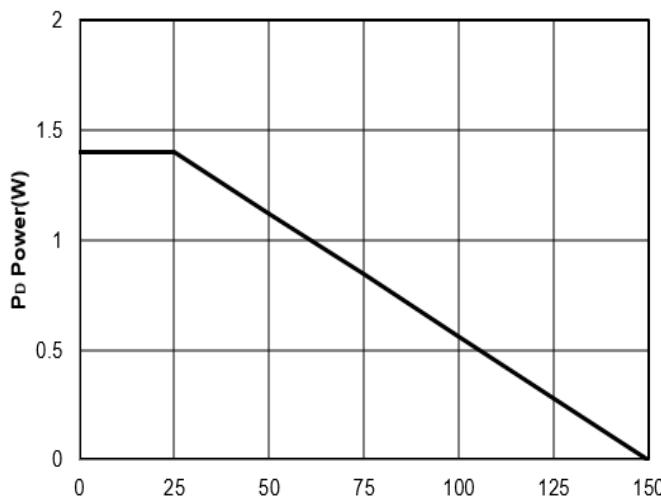
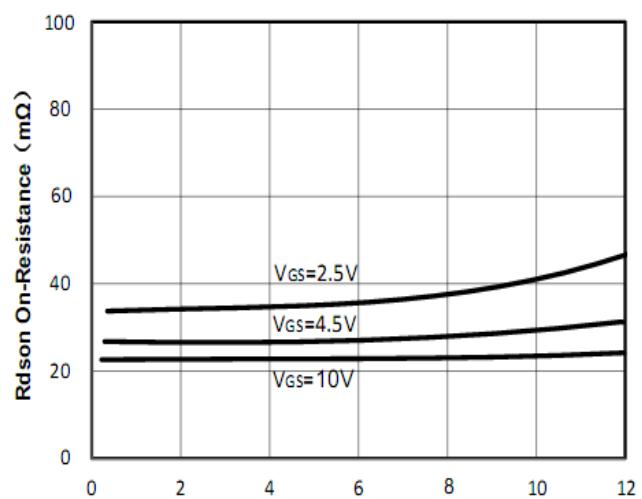
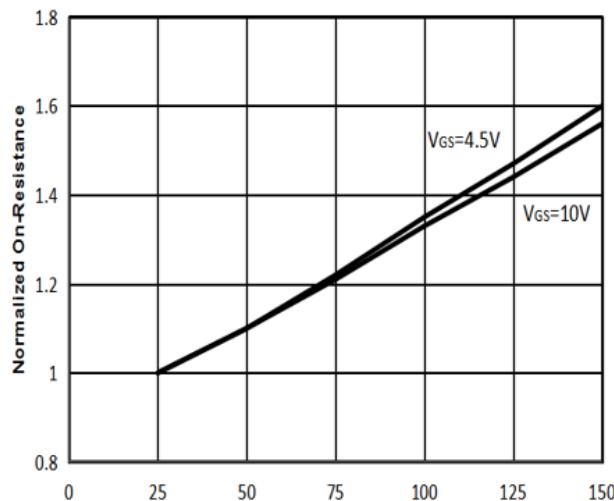
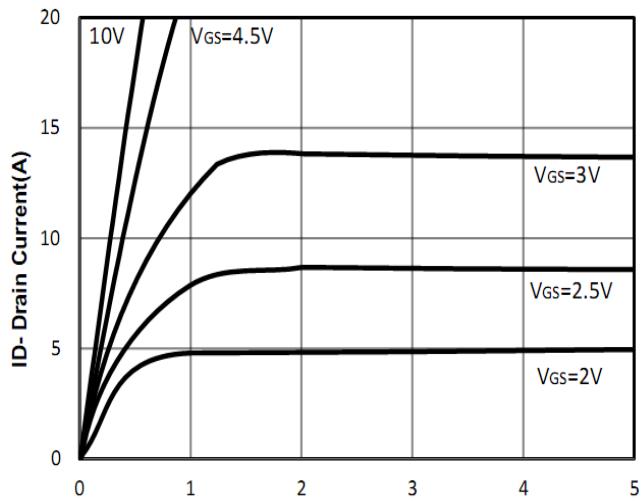
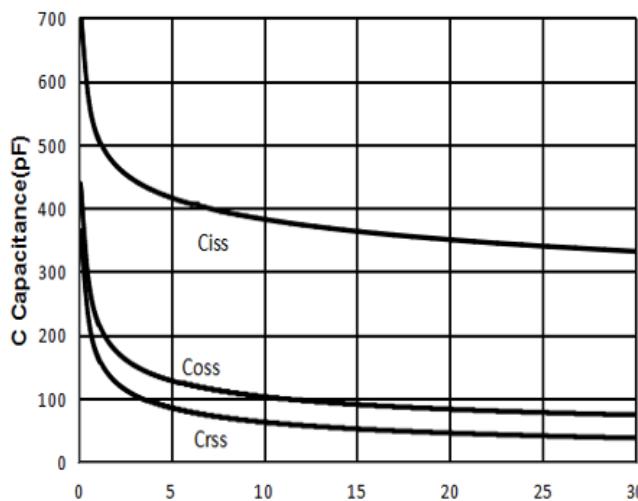
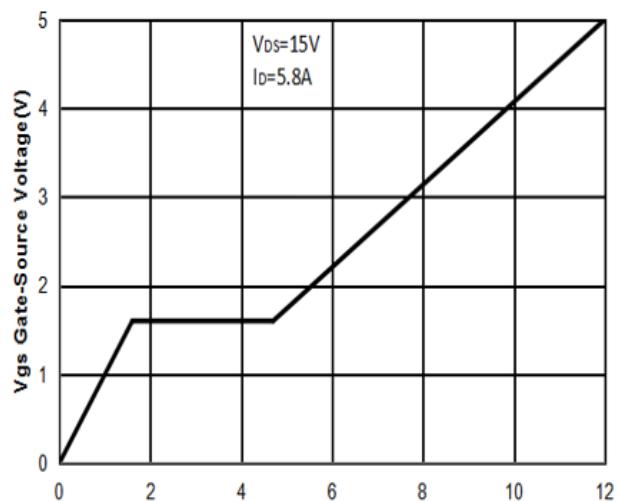


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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)</b>						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$VGS=0V$ $ID=250\mu A$	30	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain current	$VDS=24V$ , $VGS=0V$	--	--	1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$VGS=\pm 12V$ , $VDS=0V$	--	--	$\pm 100$	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$VDS=VGS$ , $ID=250\mu A$	0.7	--	1.4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	$VGS=10V$ , $ID=5.8A$	--	22	28	$m\Omega$
		$VGS=4.5V$ , $ID=5A$	--	25	33	$m\Omega$
		$VGS=2.5V$ , $ID=4A$	--	33	52	$m\Omega$
<b>Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note5)</b>						
$C_{iss}$	Input Capacitance	$VDS=10V$ , $VGS=0V$ , $F=1MHz$	--	340	--	pF
$C_{oss}$	Output Capacitance		--	115	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	33	--	pF
$Q_g$	Total Gate Charge	$VDS=15V$ , $ID=5.8A$ , $VGS=4.5V$	--	11	--	nC
$Q_{gs}$	Gate-Source Charge		--	1.6	--	nC
$Q_{gd}$	Gate-Drain Charge		--	2.8	--	nC
<b>Switching Characteristics (Note4)</b>						
$t_{d(on)}$	Turn-on Delay Time	$VDD=15V$ , $ID=1A$ , $RL=2.7\Omega$	--	7	--	nS
$t_r$	Turn-on Rise Time		--	15	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	38	--	nS
$t_f$	Turn-off Fall Time		--	3	--	nS
<b>Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)</b>						
$V_{SD}$	Forward on voltage	$IS=2.5A$ , $VGS=0V$	--	--	1.3	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: pulse width  $\leq 300$  us, duty cycle  $\leq 2\%$ .
4. Guranteed by design, not subject to production testing.

**30V/5.8A N-Channel Advanced Power MOSFET**
**Typical Characteristics**

**Figure1: T<sub>j</sub> Junction Temperature (°C)**

**Figure2: I<sub>D</sub> Drain Current (A)**

**Figure3: T<sub>j</sub> Junction Temperature (°C)**

**Figure4: V<sub>DS</sub> Drain-Source Voltage (A)**

**Figure5: V<sub>DS</sub> Drain-Source Voltage (V)**

**Figure6: Q<sub>g</sub> Gate Charge (nC)**

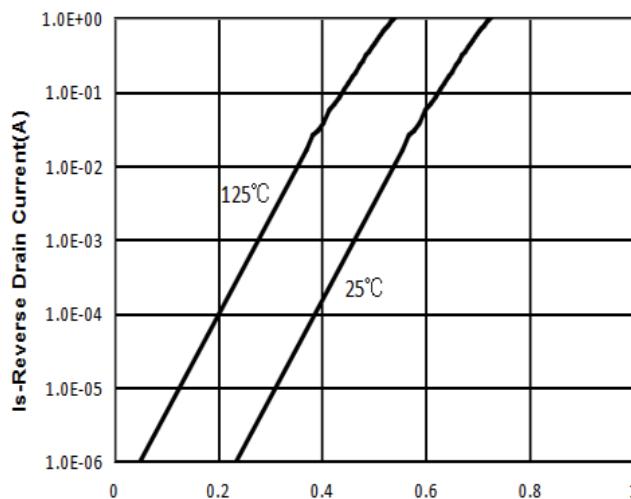
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Figure 7: V<sub>sd</sub> Source-Drain Voltage (V)

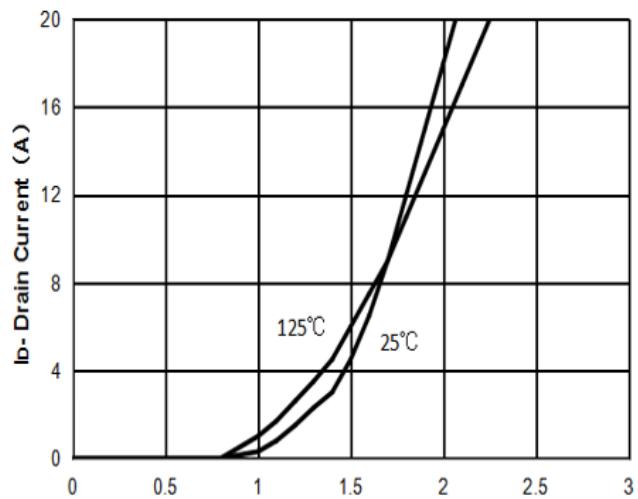


Figure 8: V<sub>gs</sub> Gate-Source Voltage (V)

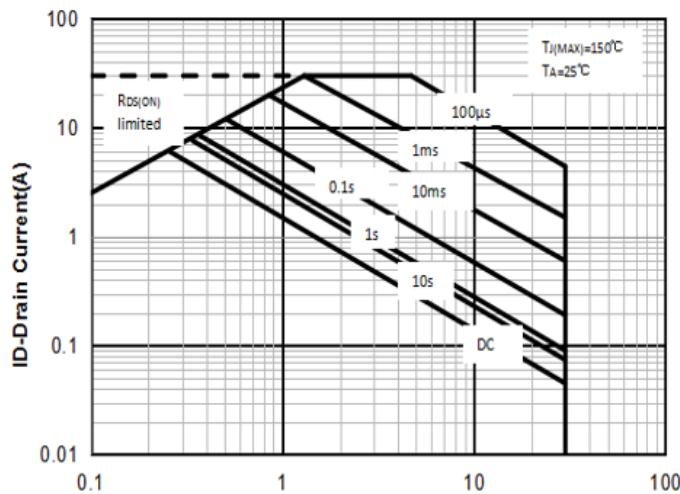


Figure 9: V<sub>ds</sub> Drain -Source Voltage (V)

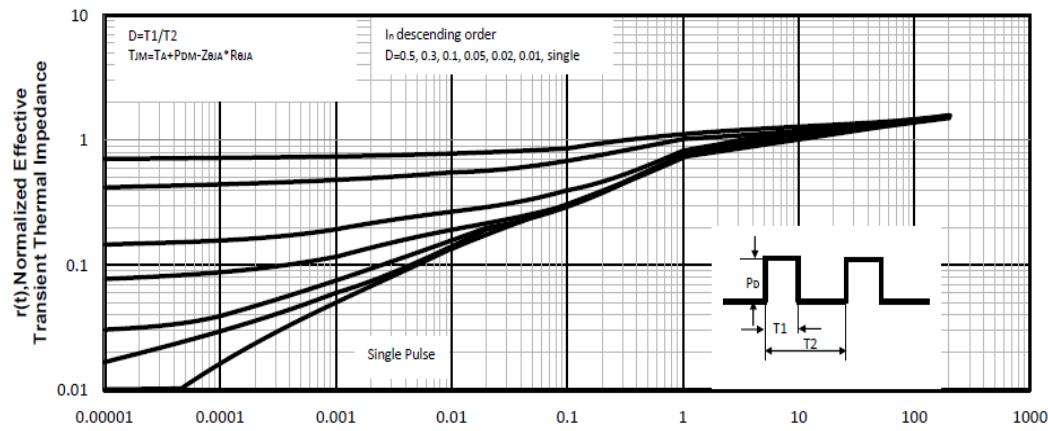
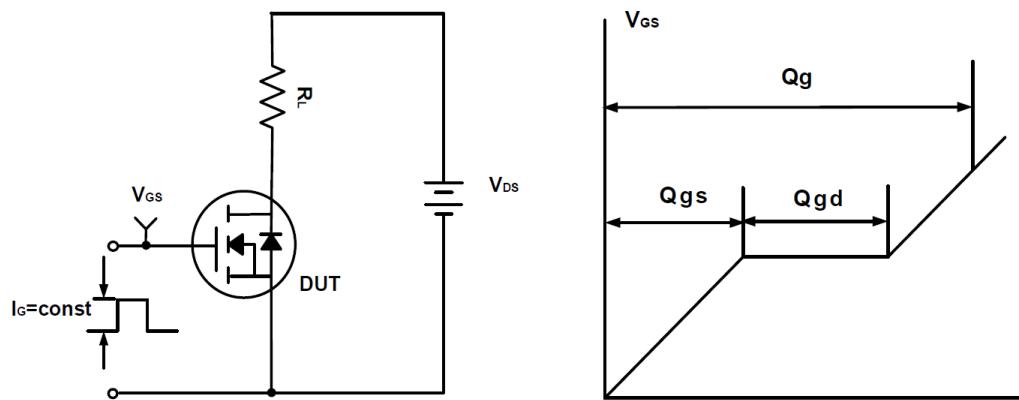
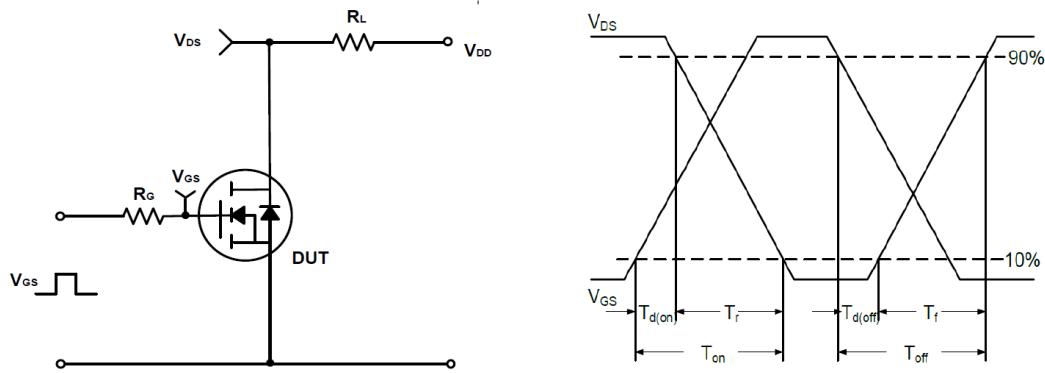
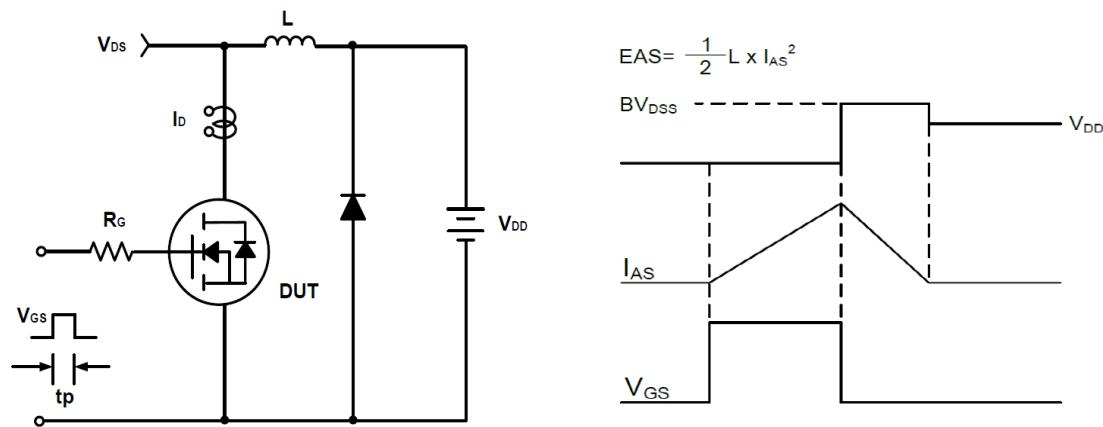
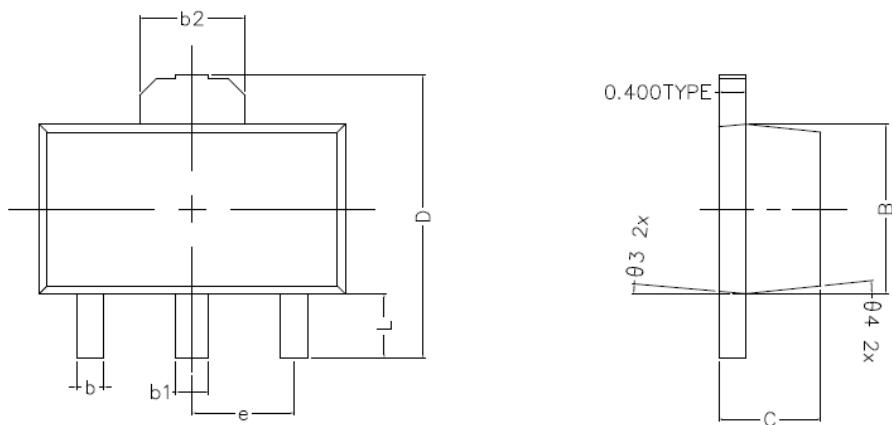
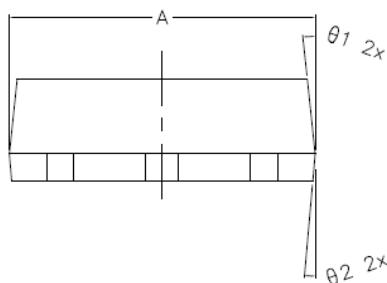


Figure 10: Square Wave Pulse Duration (sec)

**30V/5.8A N-Channel Advanced Power MOSFET**
**Test Circuit and Waveform:**

**Figure A Gate Charge Test Circuit & Waveforms**

**Figure B Switching Test Circuit & Waveforms**

**Figure C Unclamped Inductive Switching Circuit & Waveforms**

**30V/5.8A N-Channel Advanced Power MOSFET**
**SOT-89 Package Outline Dimensions (Units: mm)**


TOP VIEW



COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	4.450	4.550	4.650
B	2.450	2.550	2.650
C	1.400	1.500	1.600
D	4.100	4.200	4.300
L	0.850	0.950	1.050
b	0.350	0.400	0.450
b <sub>1</sub>	0.430	0.480	0.530
b <sub>2</sub>	1.500	1.550	1.600
e	1.500TYPE		
θ <sub>1</sub>	6° TYPE		
θ <sub>2</sub>	5° TYPE		
θ <sub>3</sub>	5° TYPE		
θ <sub>4</sub>	6° TYPE		